## Onsemi Silicon Carbide (SiC) Schottky Diode – EliteSiC, 8 A, 650 V, D2, D2PAK-2L

### **FFSB0865B**

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

#### Features

- Max Junction Temperature 175°C
- Avalanche Rated 33 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### Applications

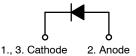
- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

| Parameter   |  | Symbol                            | Value          | Unit |  |
|---|--|-----------------------------------|----------------|------|--|
| Peak Repetitive Reverse VoltageSingle Pulse Avalanche Energy ( $T_J = 25^{\circ}C$ , $I_{L(pk)} = 11.5 \text{ A}, L = 0.5 \text{ mH}, V = 50 \text{ V}$ ) |  | V <sub>RRM</sub>                  | 650            | V    |  |
|   |  | E <sub>AS</sub>                   | 33             | mJ   |  |
| Continuous Rectified Forward  | @ T <sub>C</sub> < 147                           | ١ <sub>F</sub>                    | 8.0            | А    |  |
| Current   | @ T <sub>C</sub> < 135                           |                                   | 10.1           |      |  |
| Non-Repetitive Peak Forward<br>Surge Current  | T <sub>C</sub> = 25°C<br>t <sub>P</sub> = 10 μs  | I <sub>FM</sub>                   | 577            | A    |  |
|   | T <sub>C</sub> = 150°C<br>t <sub>P</sub> = 10 μs |                                   | 533            |      |  |
| Non-Repetitive Forward Surge<br>Current (Half-Sine Pulse)   | T <sub>C</sub> = 25°C<br>t <sub>P</sub> = 8.3 ms | I <sub>FSM</sub>                  | 56             | A    |  |
| Power Dissipation   | T <sub>C</sub> = 25°C                            | P <sub>tot</sub>                  | 73             | W    |  |
|   | T <sub>C</sub> = 150°C                           |                                   | 12             |      |  |
| Operating Junction and Storage Temperature<br>Range   |  | T <sub>J</sub> , T <sub>stg</sub> | –55 to<br>+175 | °C   |  |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

| V <sub>RRM</sub> | ١ <sub>F</sub> |  |  |
|------------------|----------------|--|--|
| 650 V            | 8.0 A          |  |  |

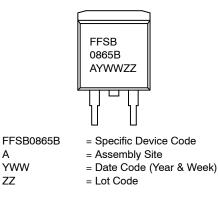


Schottky Diode



D<sup>2</sup>PAK2 (TO-263-2L) CASE 418BK

#### MARKING DIAGRAM



A

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet

#### FFSB0865B

#### THERMAL CHARACTERISTICS

| Parameter                                  | Symbol          | Value | Unit |
|--|-----------------|-------|------|
| Thermal Resistance, Junction-to-Case, Max. | $R_{\theta JC}$ | 2.05  | °C/W |

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

| Parameter          | Symbol         | Test Conditions   | Min | Тур  | Max | Unit |
|--------------------|----------------|---|-----|------|-----|------|
| ON CHARACTERISTICS |                |   |     |      | -   |      |
| Forward Voltage    | V <sub>F</sub> | $I_F = 8.0 \text{ A}, \text{ T}_J = 25^{\circ}\text{C}$             |     | 1.39 | 1.7 | V    |
|                    |                | $I_F = 8.0 \text{ A},  \text{T}_\text{J} = 125^\circ\text{C}$       |     | 1.55 | 2.0 |      |
|                    |                | $I_F = 8.0 \text{ A},  \text{T}_\text{J} = 175^\circ\text{C}$       |     | 1.71 | 2.4 |      |
| Reverse Current    | I <sub>R</sub> | $V_{R} = 650 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C}$         |     | 0.5  | 40  | μΑ   |
|                    |                | $V_{R} = 650 \text{ V},  \text{T}_{\text{J}} = 125^{\circ}\text{C}$ |     | 1.0  | 80  |      |
|                    |                | $V_{R} = 650 \text{ V},  \text{T}_{\text{J}} = 175^{\circ}\text{C}$ |     | 2.0  | 160 |      |

#### **CHARGES, CAPACITANCES & GATE RESISTANCE**

| Total Capacitive Charge | Q <sub>C</sub>   | V <sub>C</sub> = 400 V              | 22  | nC |
|-------------------------|------------------|-------------------------------------|-----|----|
|                         | C <sub>tot</sub> | V <sub>R</sub> = 1 V, f = 100 kHz   | 336 | pF |
|                         |                  | V <sub>R</sub> = 200 V, f = 100 kHz | 39  |    |
|                         |                  | V <sub>R</sub> = 400 V, f = 100 kHz | 30  |    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

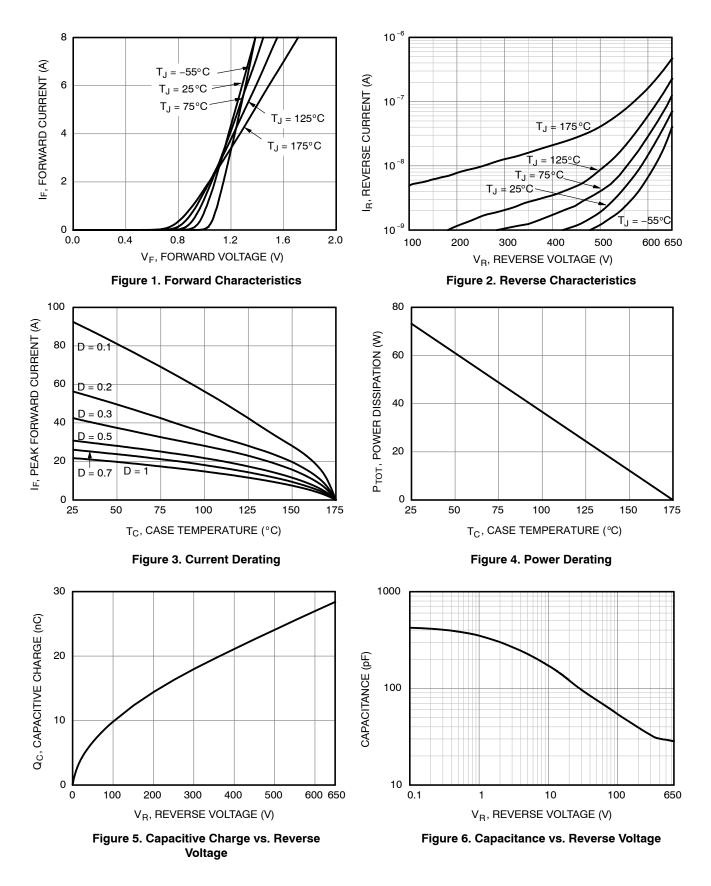
#### PACKAGE MARKING AND ORDERING INFORMATION

| Part Number | Top Marking | Package                            | Packing Method           | Reel Size | Tape Width | Quantity  |
|-------------|-------------|------------------------------------|--------------------------|-----------|------------|-----------|
| FFSB0865B   | FFSB0865B   | D <sup>2</sup> PAK2<br>(TO-263-2L) | Tape & Reel <sup>†</sup> | 330 mm    | 24 mm      | 800 Units |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

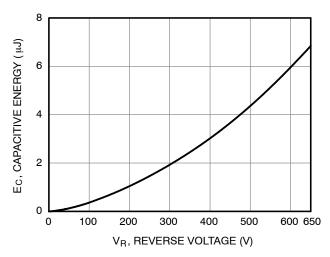
#### FFSB0865B

#### **TYPICAL CHARACTERISTICS**



#### FFSB0865B

#### **TYPICAL CHARACTERISTICS**





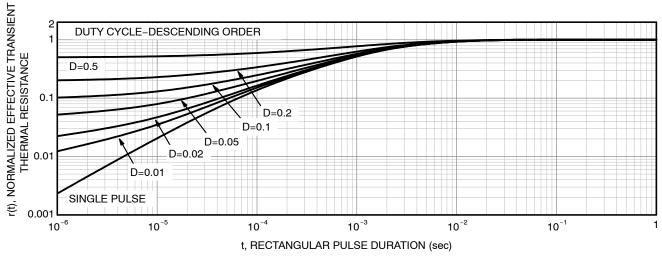
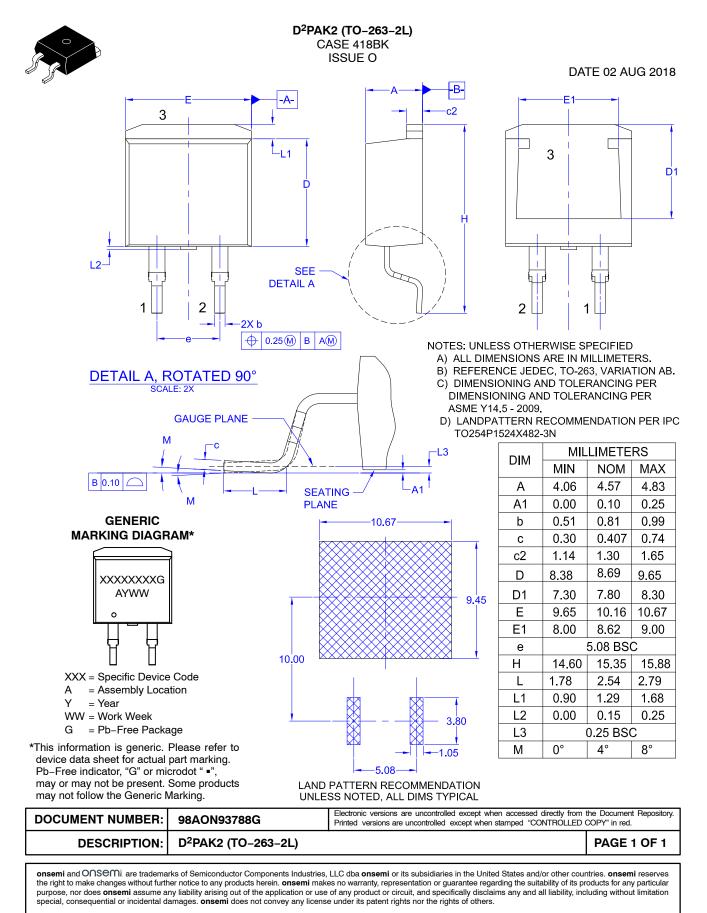


Figure 8. Junction-to-Case Transient Thermal Response

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